



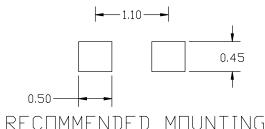
SOD-723, 2-LEAD, 1.00x0.60x0.52 CASE 509AA ISSUE A

DATE 01 FEB 2024

NDTES:

- I. DIMENSIONSING AND TOLERANCING PER ASME Y14.5M, 2018.
- 2. CONTROLLING DIMENSIONS: MILLIMETER.
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

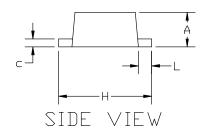
DIM	MILLIMETERS			
	MIN.	N□M.	MAX.	
А	0.49	0.52	0.55	
b	0.25	0.28	0.32	
С	0.08	0.12	0.15	
D	0.95	1.00	1.05	
E	0.55	0.60	0.65	
Н	1.35	1.40	1.45	
L	0.15	0.20	0.25	



*For additional formation on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

FUUTERINT

	- D	B
ax p		E V
(0.08 A B T P	VIEW	



GENERIC MARKING DIAGRAM*



XX = Specific Device Code M = Date Code

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DESCRIPTION:	SOD-723, 2-LEAD, 1.00x0.60x0.52		PAGE 1 OF 1

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^{*}This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.